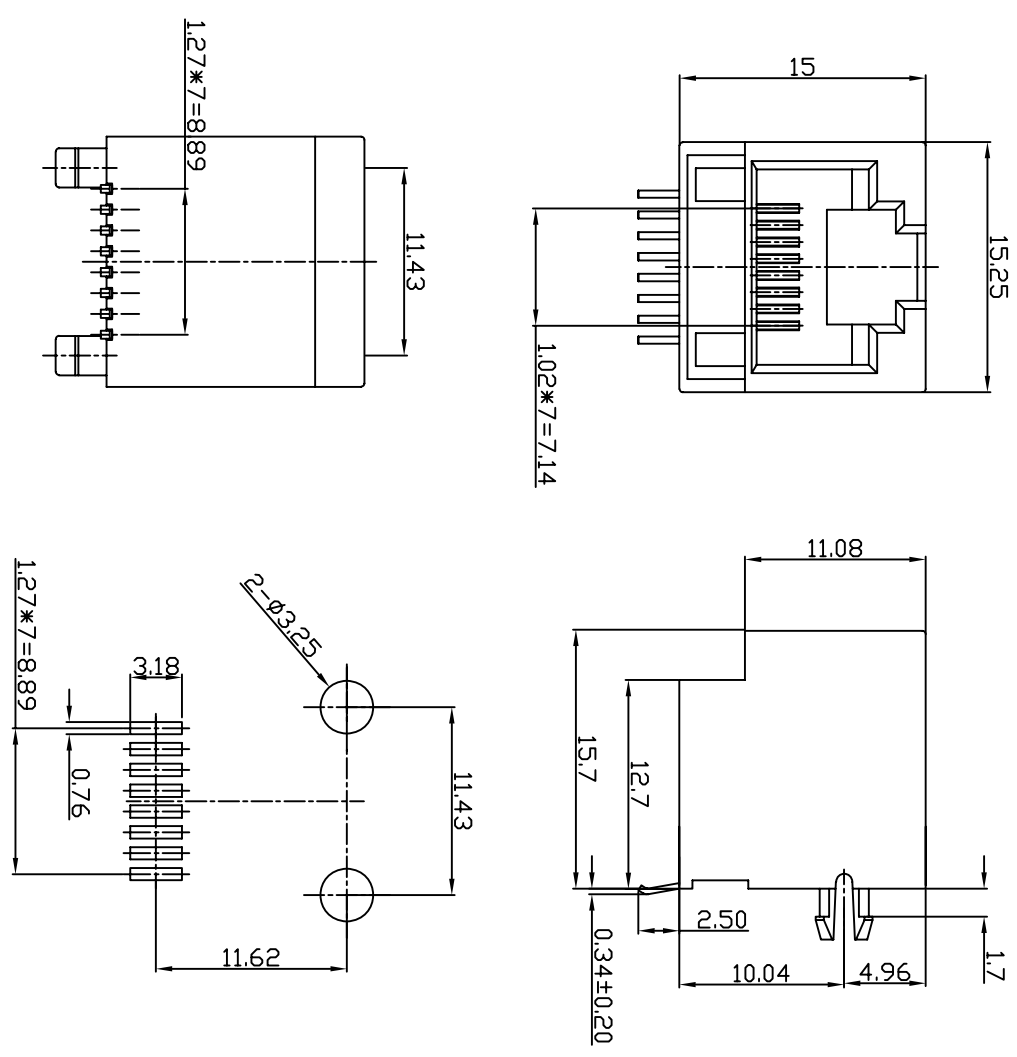


REV	ECN NO.	DATE



PC BOARD LAYOUT

NOTES

MATERIAL

- 1. HOUSING MATERIAL : HIGH TEMP THERMOPLASTIC FLAMMABILITY RATING UI94V-0.
- 2. CONTACT MATERIAL : GOLD PLATING OVER NICKEL IN CONTACT TIN PLATING OVER NICKEL IN SOLDER AREA.
- 3. PLATING : GOLD PLATING OVER NICKEL. : PU, 30°, 60°, 150°, 30°, 50°.

ELECTRICAL

- 1. VOLTAGE RATING : 125 VAC RMS.
- 2. CURRENT RATING : 1.5 AMP.
- 3. CONTACT RESISTANCE : 30 MILLIOHMS MAX.
- 4. INSULATION RESISTANCE : 500 MEGOHMS MIN @ 500V DC.
- 5. DIELECTRIC DIELECTRIC RESISTANCE : 1000V AC RMS 50HZ. 1MIN.

MECHANICAL

- 1. DURABILITY : 750 CYCLES MIN.
- 2. PCB RETENTIONPRE-SOLDER : 1 LB MIN.

ENVIRONMENTAL:

- 1. STORAGE : -40°C~+85°C.
- 2. OPERATION : 0° C 10 70° C.

RoHS Compliant

TIAN MU ELECTRONIC CO.,LTD

RJ45 JACK 有落差

TOLERANCES		DATE		TITEL	
mm	公差	日期	2013-09-26	品名	RJ45 JACK 有落差
± 0.30	±	材料		料号	TM-52FSMT801
± 0.25	±	FINISH		PART NO.	TM-52FSMT801
± 0.10	±	电镀		比例	1:1
ANGLES		SCALE		UNIT	
± 1°		1:1		mm	
THIRD ANGLE PROJECTION		Designed		Checked	
设计		张旺新		审核	
3		10		Approved	
4		核准		SHEET 1 OF 1	
SIZE		A4		A4	